



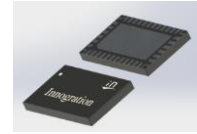
## 50W,50V Plastic RF LDMOS Transistor

**ITGV10050C6**

### Description

The ITGV10050C6 is a 50V 50-watt, highly rugged, LDMOS transistor, designed for any general applications at frequencies up to 1GHz, in 10\*6mm QFN plastic package, supporting surface mounted on PCB through high density grounding vias.

When used at 28V, it can be 25W with more ruggedness margin



- Typical Class AB RF Performance (On Innegration fixture with device soldered).

V<sub>ds</sub>=50V Idq=160mA

Freq (MHz)	Pulse CW Signal			P <sub>avg</sub> =35dBm WCDMA Signal		
	Gain P1dB (dB)	P3dB (W)	Eff@P3dB (%)	Gp (dB)	Eff(%)	ACPR <sub>5M</sub> (dBc)
758	16.86	63.63	63.42	17.70	15.98	-46.16
803	16.93	61.25	64.99	18.04	16.49	-47.08
821	16.72	58.94	64.77	18.02	16.73	-46.99

- Typical broadband Class AB RF Performance (On Innegration fixture with device soldered).

V<sub>ds</sub>=28V Idq=100mA, CW

Freq (MHz)	P1dB (dBm)	P1dB (W)	P1dB Eff (%)	P1dB Gain (dB)	P3dB (dBm)	P3dB (W)	P3dB Eff (%)
500	43.97	24.9	72.3	18.87	44.81	30.3	77.8
600	43.37	21.7	67.6	18.28	44.32	27.0	72.1
700	43.97	25.0	61.6	17.98	44.8	30.2	65.4
800	43.79	23.9	58.8	18.64	44.75	29.9	62.5
900	43.08	20.3	57.4	18.65	44.31	27.0	62.2
1000	42.28	16.9	57.4	17.51	43.38	21.8	60.1

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- P band power amplifier
- All 4G/5G cellular application within 0.5 to 1GHz

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	+110	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+55	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C



Operating Junction Temperature	$T_J$	+225	°C
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**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_C = 85^\circ\text{C}$ , $T_J = 200^\circ\text{C}$ , DC test	$R_{\theta JC}$	1.2	°C/W

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

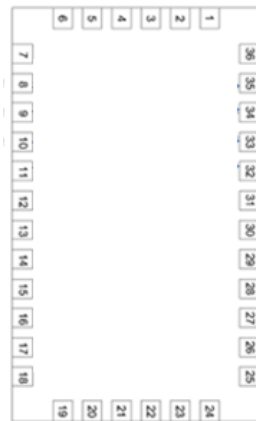
**Table 4. Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics</b> Drain-Source Voltage $V_{GS} = 0$ , $I_{DS} = 100\mu\text{A}$	$V_{(BR)DSS}$		110		V
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 90\text{V}$ , $V_{GS} = 0\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate--Source Leakage Current ( $V_{GS} = 11\text{V}$ , $V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	1	$\mu\text{A}$
Gate Threshold Voltage ( $V_{DS} = 50\text{V}$ , $I_D = 600\mu\text{A}$ )	$V_{GS(th)}$	—	2	—	V
Gate Quiescent Voltage ( $V_{DD} = 50\text{V}$ , $I_D = 160\text{mA}$ , Measured in Functional Test)	$V_{GS(Q)}$	—	3.36	—	V

**Load Mismatch (In Innogrations Test Fixture, 50 ohm system):**  $V_{DD} = 50\text{Vdc}$ ,  $I_{DQ} = 160\text{mA}$ ,  $f = 1000\text{MHz}$

VSWR 10:1 at 50W pulse CW Output Power	No Device Degradation
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**Figure 1: Pin Definition (Top View)**



Pin No.	Symbol	Description
8,9,10,11,	Vgs/RF In	Vgs and RF input
32,33,34,35	Vds/RF out	Vds and RF output
2,5,7,12,13,18,20,23,25,30,31,36	GND	DC/RF Ground
Others	NC	No connection
Package Base	GND	DC/RF Ground.

## 758-821MHz 50V application board

### Reference Circuit of Test Fixture Assembly Diagram 20mils RO4350B

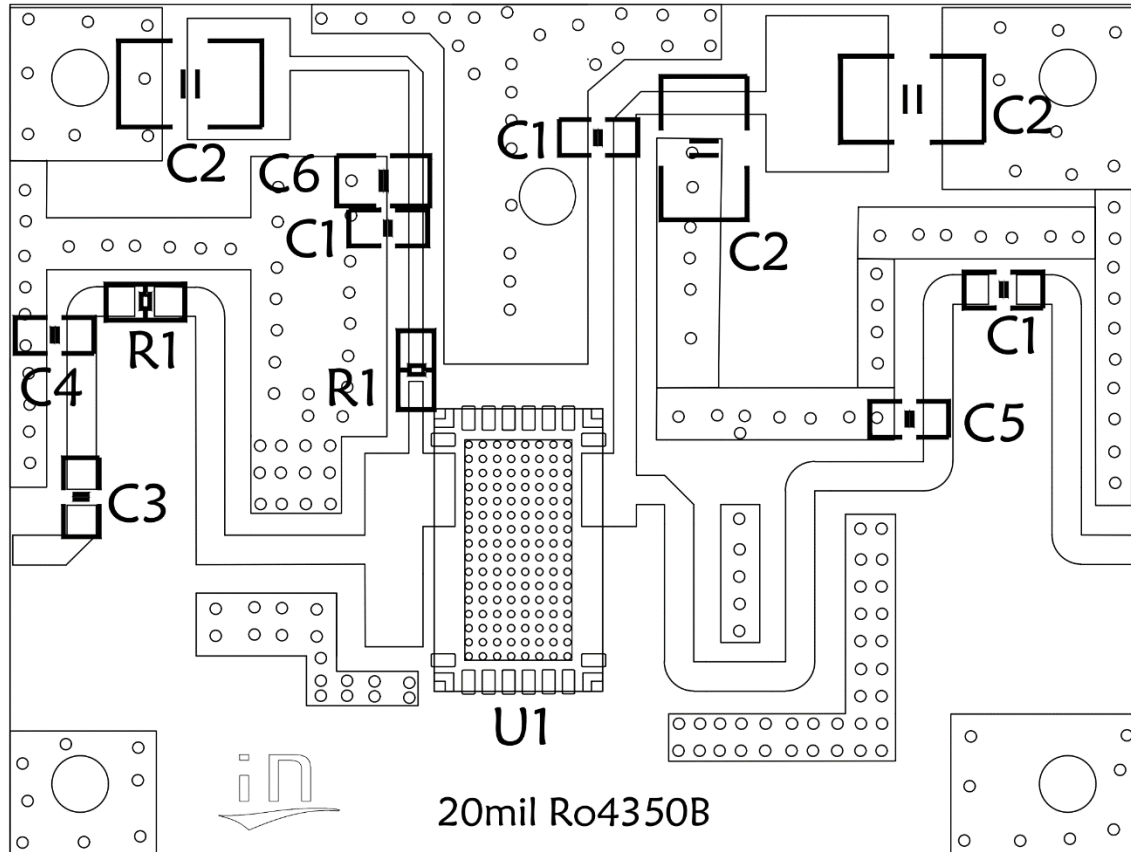


Figure 2. Test Circuit Component Layout

Table 5. Test Circuit Component Designations and Values

Reference	Footprint	Value	Quantity
C1	0805	68pF/250V	3
C2	1210	10uF/100V	3
C3	0805	3.0pF/250V	1
C4	0805	3.9pF/250V	1
C5	0805	3.6pF/250V	1
C6	0805	10uF/16V	1
R1	0603	10R	2
U1	C6	ITGV10050C6	1



### TYPICAL CHARACTERISTICS

Figure 5. Power Gain and Drain Efficiency as function of Power Output at Idq=160mA

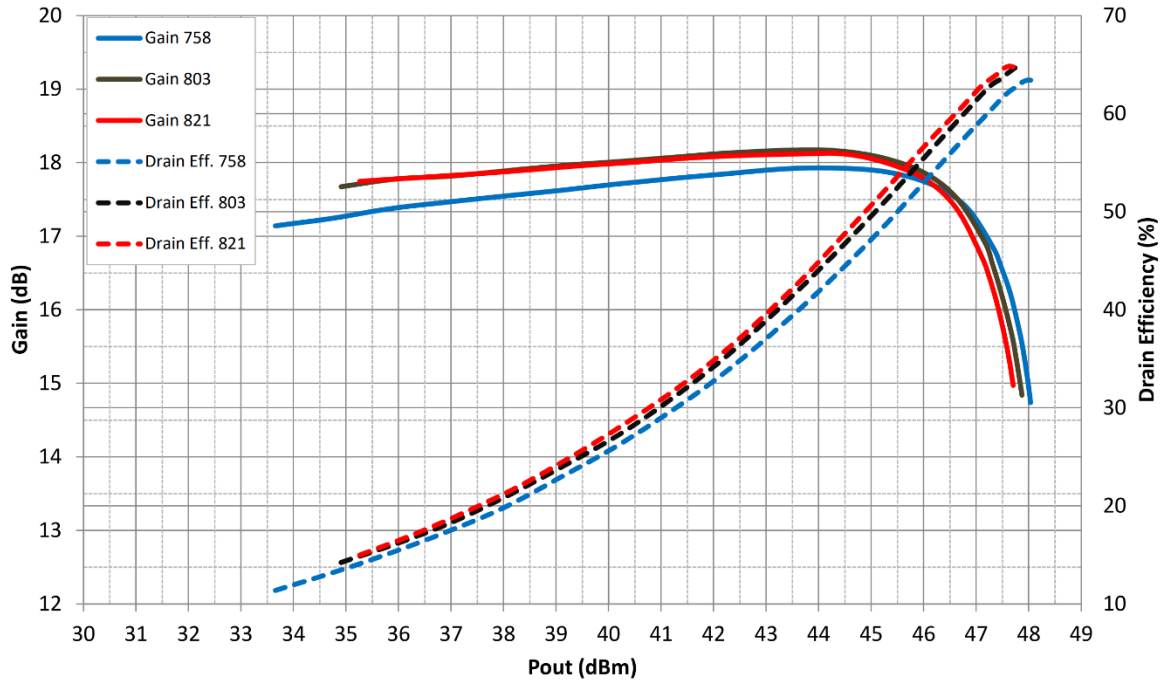
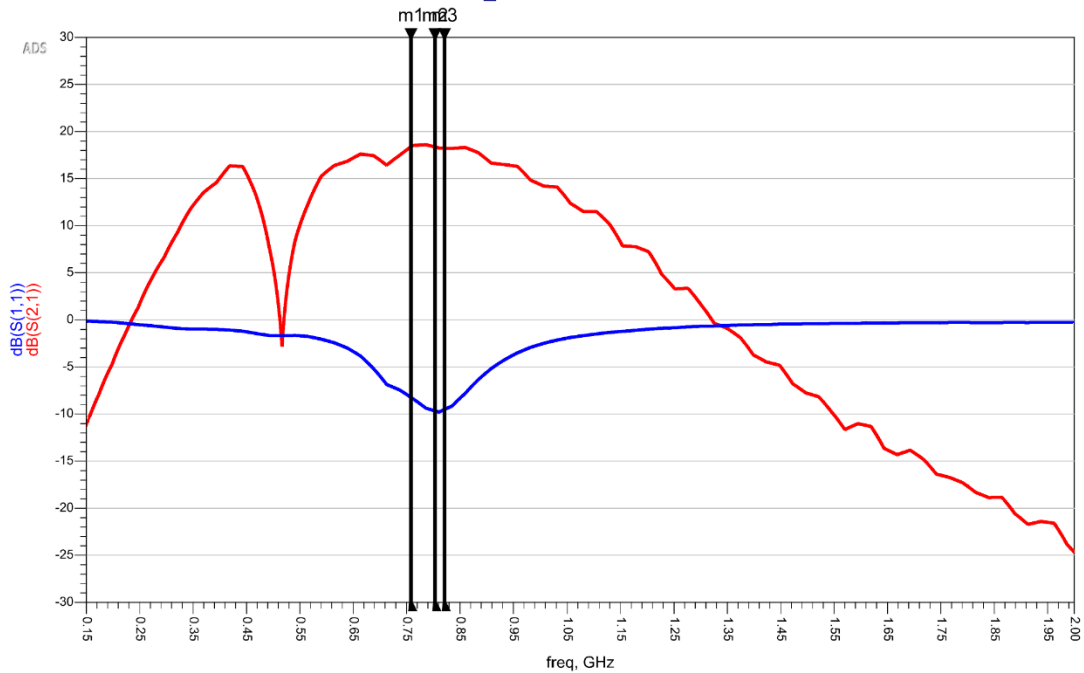


Figure 6. Network analyzer output S11/S21

<b>m1</b> freq=758.0 MHz dB(S(2,1))=18.375 dB(S(1,1))=-8.229	<b>m2</b> freq=803.0 MHz dB(S(2,1))=18.356 dB(S(1,1))=-9.667	<b>m3</b> freq=821.0 MHz dB(S(2,1))=18.226 dB(S(1,1))=-9.517
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### S-Parameters\_ITGV10050C6 Class AB



**500-1000MHz 28V application board**  
**Reference Circuit of Test Fixture Assembly Diagram**  
**20mils RO4350B**

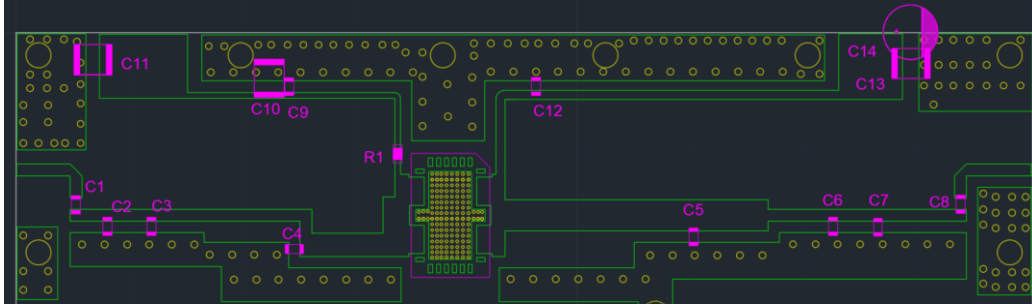


Figure 7. Test Circuit Component Layout

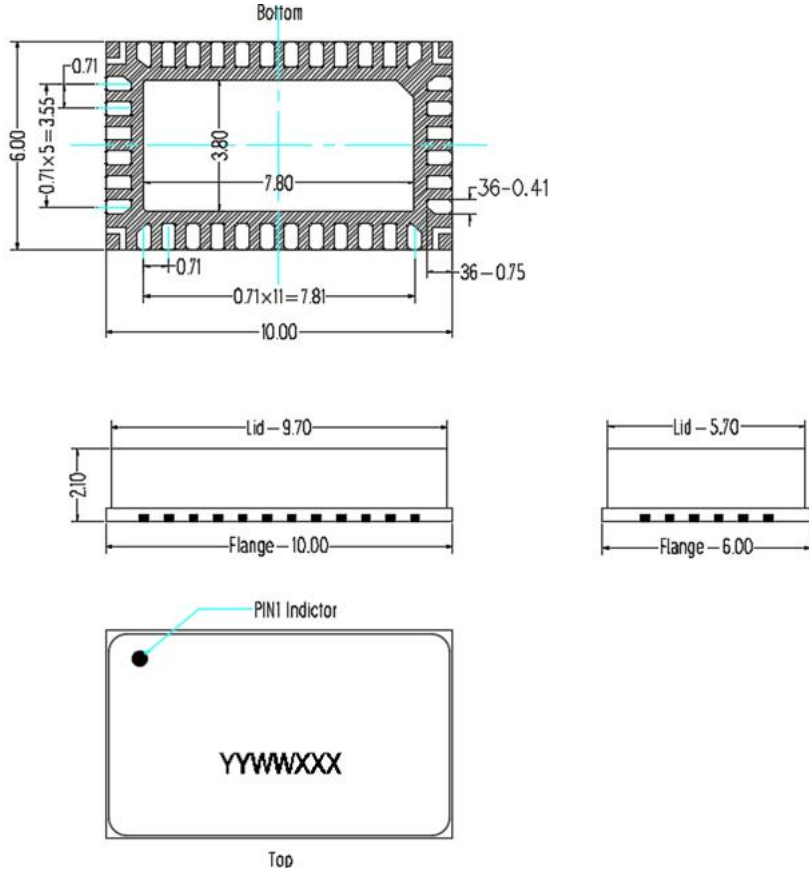
Table 6. Test Circuit Component Designations and Values

Reference	Footprint	Value	Quantity
C1	0603	47 pF	1
C2	0603	0.9 pF	1
C3,C5	0603	2.4 pF	2
C4	0603	6.8 pF	1
C6,C7	0603	1.2 pF	2
C8,C9,C12	0603	68 pF	3
C10,C11,C13	1210	10 uF/63V	3
C14	/	470 uF	1
R1	0603	10 ohm	1
U1	C6	ITGV10050C6	1



### Package Dimensions

#### 10\*6 Plastic Package



Notes:

- 1. All dimensions are in mm;
- 2. The tolerances unless specified are ±0.2mm.

### Revision history

Table 7. Document revision history

Date	Revision	Datasheet Status
2022/1/6	Rev 1.0	Preliminary Datasheet
2026/4/14	Rev 1.1	Add 28V broadband data

Application data based on ZBB-23-01/CWZ-26-07

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